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SEMICONDUCTOR IM

FDD5614P

60V P-Channel PowerTrench[®] MOSFET

NW.DZSC

General Description

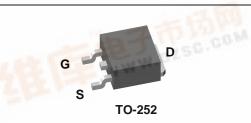
This 60V P-Channel MOSFET uses Fairchild's high voltage PowerTrench process. It has been optimized for power management applications.

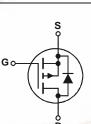
Applications

- DC/DC converter
- · Power management
- Load switch

Features

- $-15 \text{ A}, -60 \text{ V}. \text{ R}_{DS(ON)} = 100 \text{ m}\Omega @ \text{V}_{GS} = -10 \text{ V}$ $R_{\text{DS(ON)}}$ = 130 m Ω @ V_{GS} = -4.5 V
- · Fast switching speed
- High performance trench technology for extremely low R_{DS(ON)}
- High power and current handling capability





Absolute Maximum Ratings	T _A =25°C unless otherwise noted
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Symbol	Parameter	392 7	Ratings	Units
V _{DSS}	Drain-Source Voltage		-60	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Drain Current – Continuous	(Note 3)	-15	A
	– Pulsed	(Note 1a)	-45	
Po	Power Dissipation for Single Operation	(Note 1)	42	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C
Therma	I Characteristics	-	B DE WWW	.07.55
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	3.5	°C/W
R _{eja}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
R _{eJA}	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

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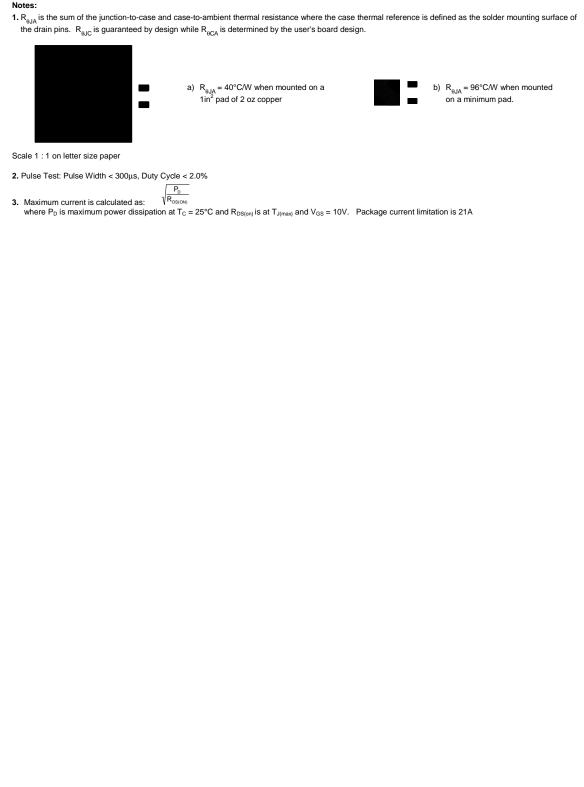
Device Marking	Device	Reel Size	Tape width	Quantity
FDD5614P	FDD5614P	13"	12mm	2500 units

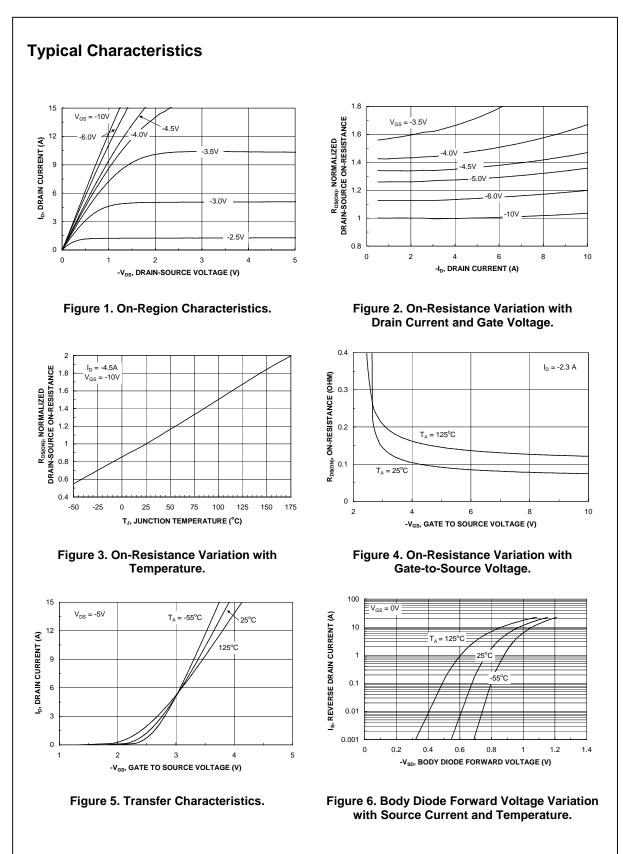


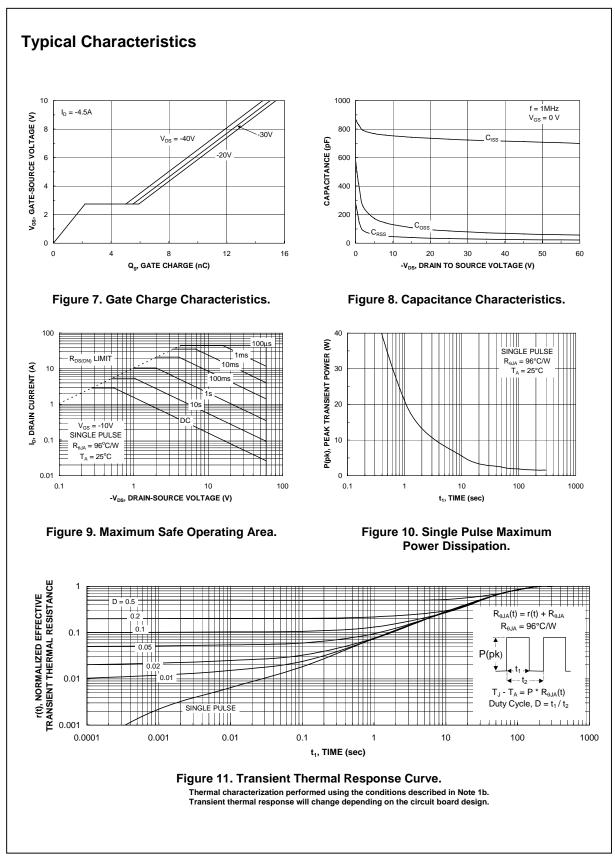
FDD5614P

February 2001

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
-	United Avalanche Ratings (Note	0				
W _{DSS}	Single Pulse Drain-Source	$V_{DD} = -30 V$, $I_D = -4.5 A$			90	mJ
	Avalanche Energy				4 -	
I _{AR}	Maximum Drain-Source Avalanche Current				-4.5	A
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-60			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		-49		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -48 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	μA
	Gate-Body Leakage, Forward	$V_{GS} = 20V, \qquad V_{DS} = 0 \ V$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = -10 \ V, & I_D = -4.5 \ A \\ V_{GS} = -4.5 \ V, & I_D = -3.9 \ A \\ V_{GS} = -10 \ V, I_D = -4.5 \ A, T_J = 125^\circ C \end{array} $		76 99 137	100 130 185	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$	-20			A
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -3 A$		8		S
Dvnamio	Characteristics					•
C _{iss}	Input Capacitance	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		759		pF
Coss	Output Capacitance			90		pF
Crss	Reverse Transfer Capacitance	-		39		pF
	g Characteristics (Note 2)		•			
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -30 \text{ V}.$ $I_D = -1 \text{ A}.$		7	14	ns
t _r	Turn–On Rise Time			10	20	ns
t _{d(off)}	Turn–Off Delay Time	1	<u> </u>	19	34	ns
t _f	Turn–Off Fall Time	1		12	22	ns
Qg	Total Gate Charge	$V_{DS} = -30V$, $I_D = -4.5 A$,		15	24	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -10 V$		2.5		nC
Q _{gd}	Gate-Drain Charge]		3.0		nC
	ource Diode Characteristics	and Maximum Ratings				
I _S	Maximum Continuous Drain-Source				-3.2	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = -3.2 \text{ A} (\text{Note 2})$		-0.8	-1.2	V







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